mail

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

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C 091 D Characteristics

General Characteristics	Standard	Charact	eristics									
Number of contacts		3	4	5	5 Stereo	6	7	7	8	12	14	
View on termination side of male contact insert												
Contact arrangement	DIN EN 61076-2-106	03-a ✓	04-a ✓	05-a ✓	05-b ✓	06-a ✓	07-a ✓	07-b ✓	08-a ✓	12-a ✓	14-a ✓	
Contact arrangement	IEC 60130-91)	\checkmark	\checkmark		\checkmark	\checkmark		\checkmark	\checkmark			
Electrical Characteristics												
Rated voltage ²⁾	IEC 60664-1				100 V ≃ (32 V ≃)				100 V ≃ (32 V ≃)		150 V ≃ (32 V ≃)	
Rated voltage	UL 1977								60) V		
Rated impulse withstand voltage $^{\mbox{\tiny 2)}}$	IEC 60664-1	1500 V (840 V)			1200 V (500 V)		0 V 0 V)	1200 V (500 V)				
Pollution degree ²⁾	IEC 60664-1	1 (3 3)										
Installation category	IEC 60664-1	1										
Insulation group	IEC 60664-1	II, 400 ≤ CTI < 600										
Current rating	IEC 60512-5-2 UL 1977	5 A / + 40 °C / + 104 °F3 A / + 40 °Cplease refer also to current derating curves page 59+ 104 °F									-	
Insulation resistance	IEC 60512-3-1	> 10 ¹⁰ Ω ⁴)										
Contact resistance	IEC 60512-2-1	< 5 m Ω										
Climatic Characteristics												
Climatic category	IEC 60668-1	40 / 100 / 56										
Temperature range	IEC 60668-1	- 40 °C + 100 °C / - 40 °F + 212 °F										
Salt Spray Resistance	DIN IEC 60068- 2-11, Test Ka	720h										
Mechanical Characteristics												
IP-degree	IEC 60529	IP 67 and IP 65 (in mated condition)										
Insertion and withdrawal forces	IEC 60512-13-2	25 N 30 N 35 N 50 N 55 N 60 N 90.oz 110.oz 125.oz 180.oz 200.oz 220.oz 1) N).oz			
Mechanical operation	IEC 60512-9-1	Silver ≥ 500 mating cycles Gold ≥ 1000 mating cycles										
Materials												
Housing material		coupling ring brass, strain relief, die cast, nickel plated										
Dielectric material		thermoplastic										
Contact plating		silver plated / gold plated $^{5)}$										
Further Characteristics												
Termination technique		solder, crimp										
Wire gauge		solder: ≤ 0,5 mm² / 20 AWG crimp: 2 - 6 pol (excluding 5S): 0,09 - 1,00 mm² / 28 - 18 AWG crimp: 5S, 7, 7S and 8-pol.: 0,09 - 0,75 mm² / 28 - 20 AWG / 28 - 24 AW								AWG 9-0,25 mm²		
Flammability		UL 94 V0										
Locking system	IEC 60130-9 DIN EN 61076-2-106	metal screw coupling; tightening torque 0,7 Nm										
UL	UL 1977	Conditions of acceptability										
		prest under lead. Metal housing parts shall be securely incorporated to protected ground										

Caution: Do not connect or disconnect under load. Metal housing parts shall be securely incorporated to protected ground. ¹⁾ Edition 2000-05

²⁾ values in brackets are according to DIN EN 61076-2-106

³⁾ designed acc. pollution degree 2; can be used under pollution degree 3 when the rules of IEC 60644-1 are fulfilled

 $^{\rm 4)}$ under operating conditions >10^8 Ω

⁵⁾ Remark for gold plated contacts: In order to avoid brittle inter-metallic connections, gold-plated terminals have to be tin-plated in the solder area.

IEC 60 664 ≙ DIN VDE 0110 ; IEC 60 512-x ≙ DIN EN 60 512-x; IEC 60 130-9 ≙ DIN EN 60 130-9; IEC 61076-2-106 ≙ DIN EN 61076-2-106